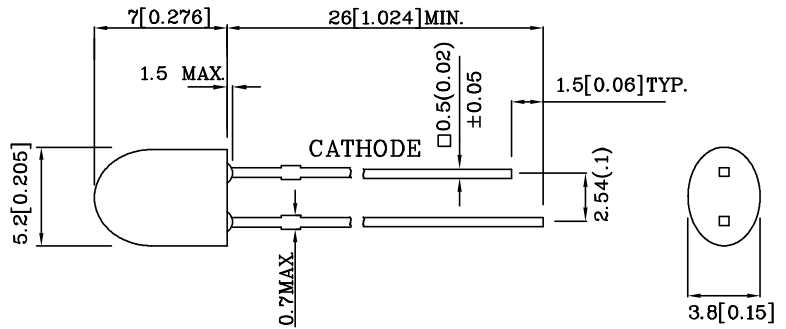


**Features**

- OUTSTANDING MATERIAL EFFICIENCY.
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**ATTENTION**  
 OBSERVE PRECAUTIONS  
 FOR HANDLING  
 ELECTROSTATIC  
 DISCHARGE  
 SENSITIVE  
 DEVICES



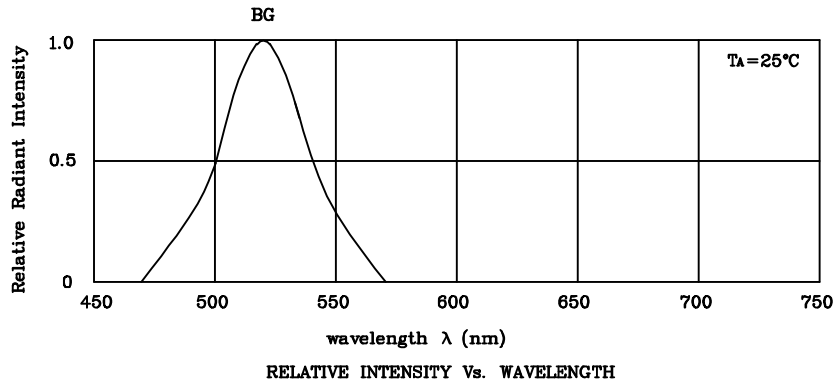
Notes:

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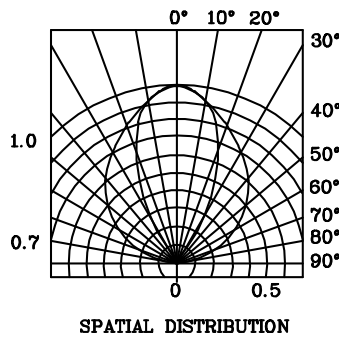
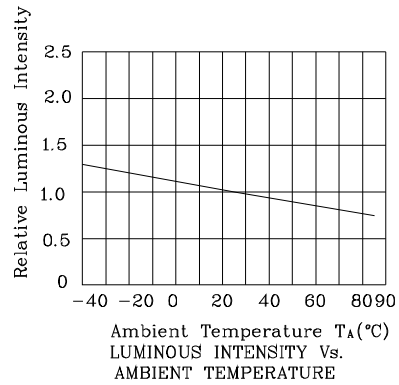
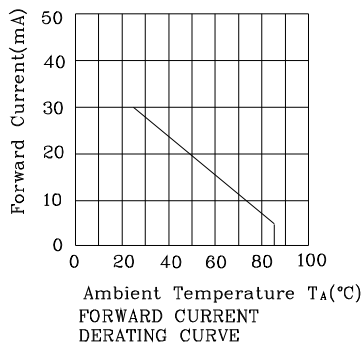
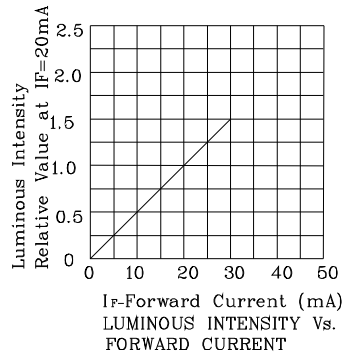
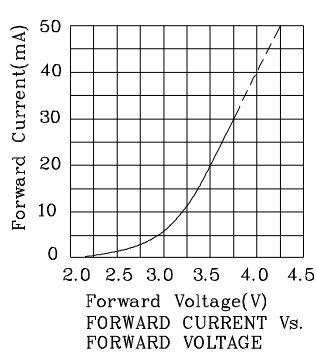
Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		BG (InGaN)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	150	mA
Power dissipation	$P_R$	105	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		BG (InGaN)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	3.5	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	4.5	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	520	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	525	nm
Spectral Line half- width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	38	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLBG20DLS DLCR	Green	InGaN	Green Semi Diffused	180	445	520	100°(H) 50°(V)



❖ **BG**

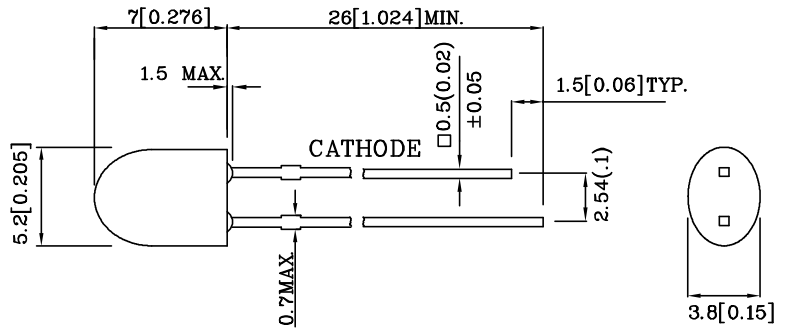


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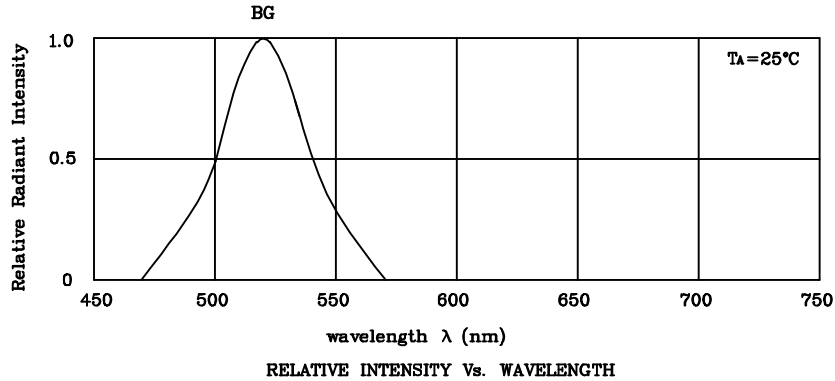
Notes:

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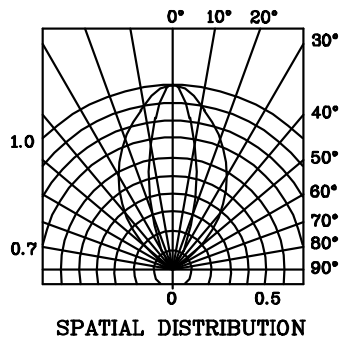
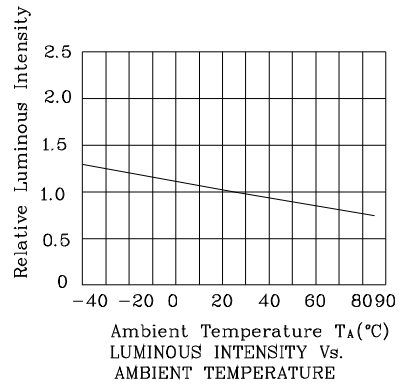
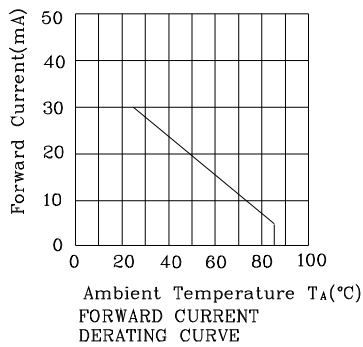
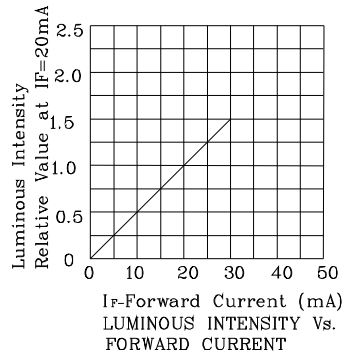
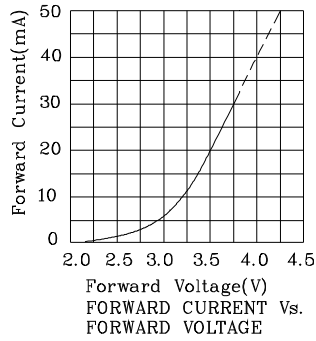
Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		BG (InGaN)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	150	mA
Power dissipation	$P_T$	105	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		BG (InGaN)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	3.5	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	4.5	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	520	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	525	nm
Spectral Line half- width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	38	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLBG20WLCR	Green	InGaN	Water Clear	380	749	520	70°(H) 30°(V)

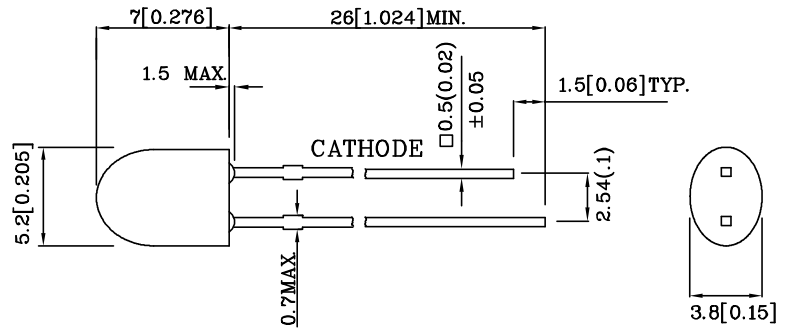


❖ **BG**



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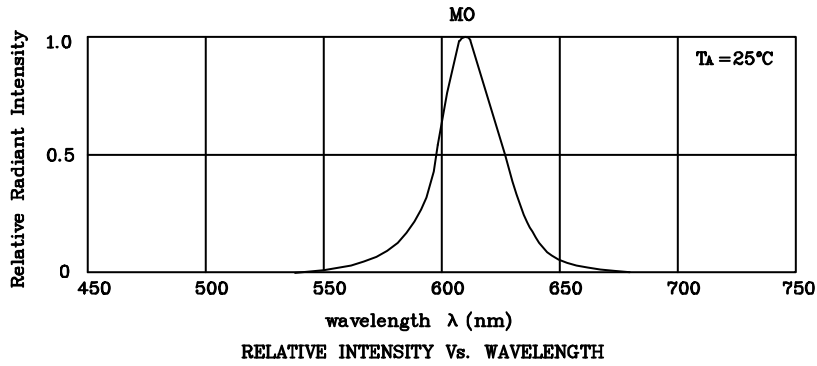
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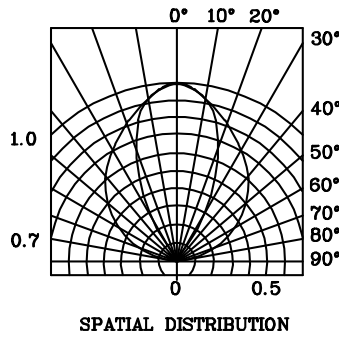
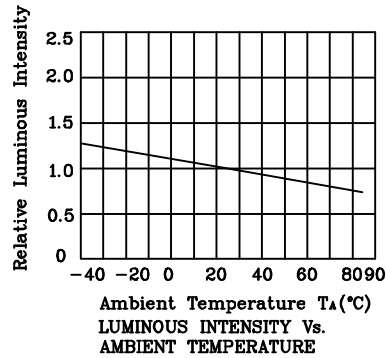
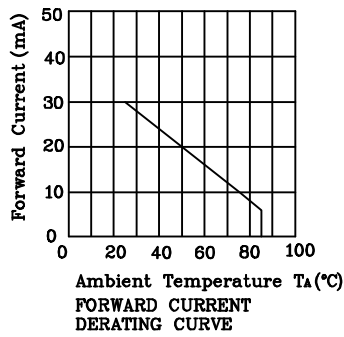
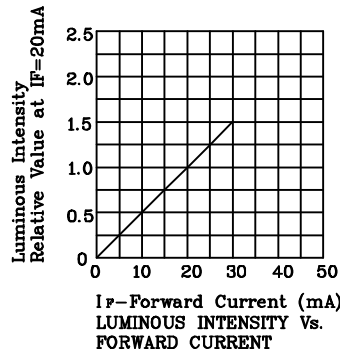
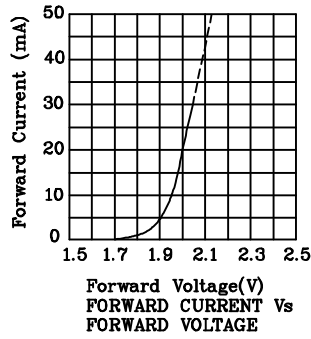
Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		MO (InGaAlP)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	195	mA
Power dissipation	$P_T$	75	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		MO (InGaAlP)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	2.0	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	2.5	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	610	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	601	nm
Spectral Line half- width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	29	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	30	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLMO20DLS DLCR	Orange	InGaAlP	Red Semi Diffused	480	995	610	100°(H) 50°(V)

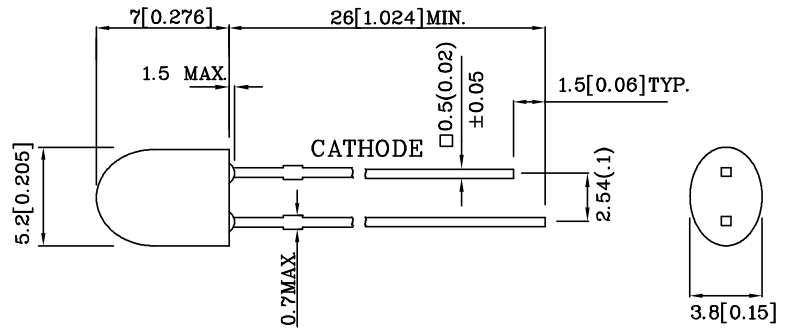


❖ MO



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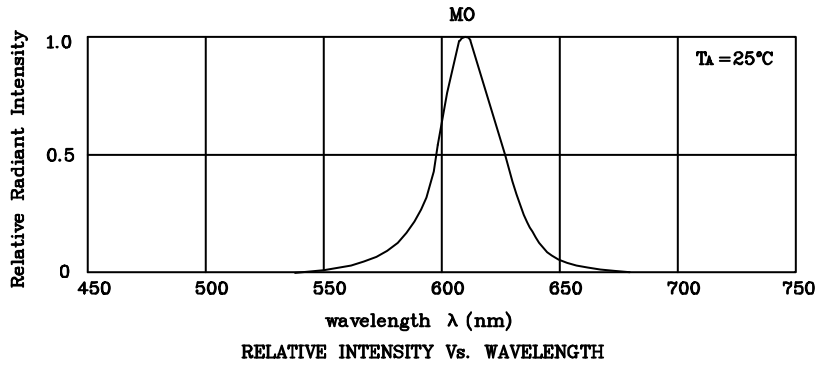
Notes:

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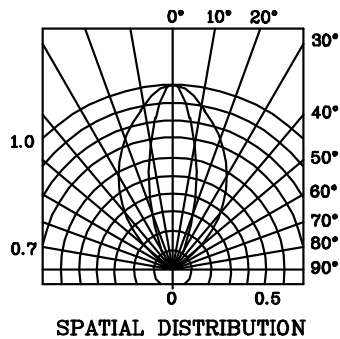
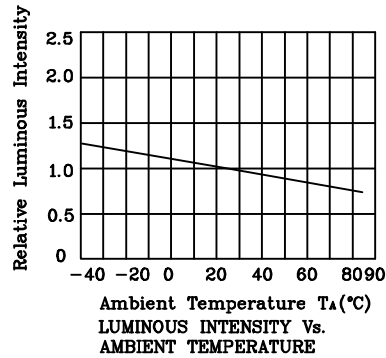
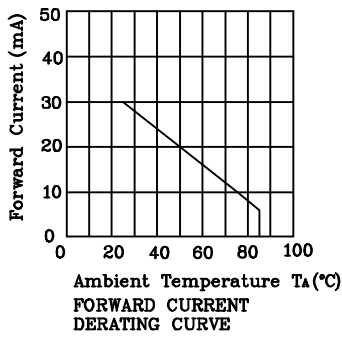
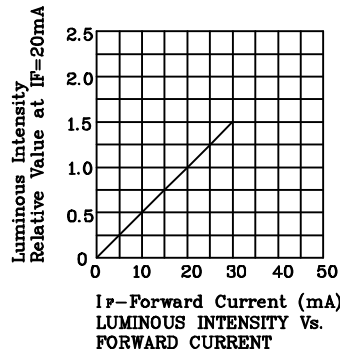
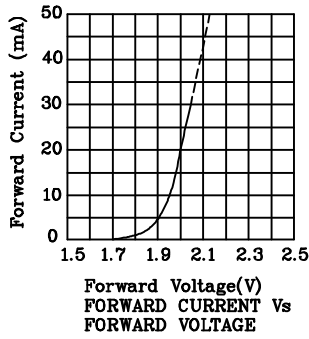
Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		MO (InGaAlP)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	195	mA
Power dissipation	$P_T$	75	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		MO (InGaAlP)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	2.0	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	2.5	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	610	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	601	nm
Spectral Line half- width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	29	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	30	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLMO20WLCR	Orange	InGaAlP	Water Clear	480	895	610	70°(H) 30°(V)



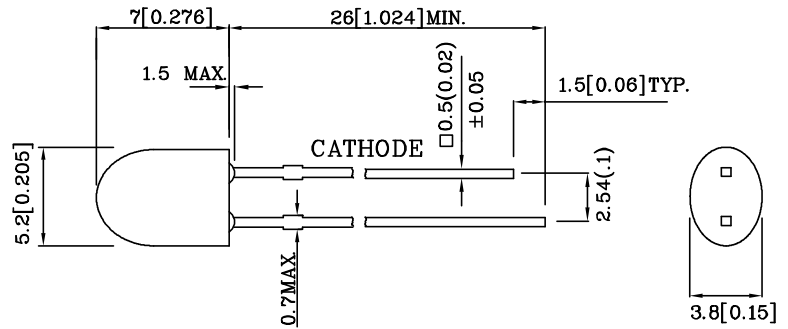
❖ MO





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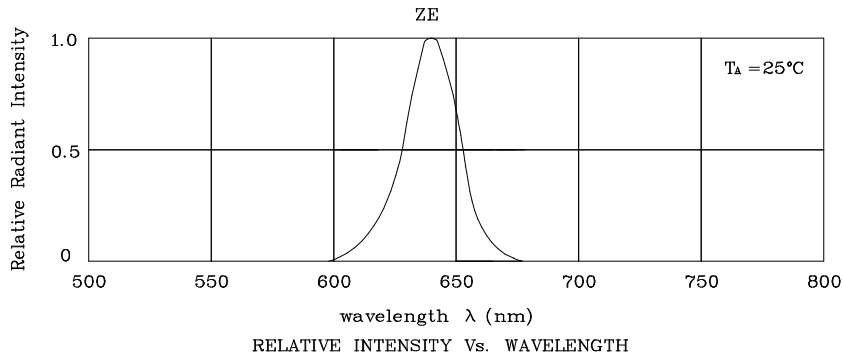
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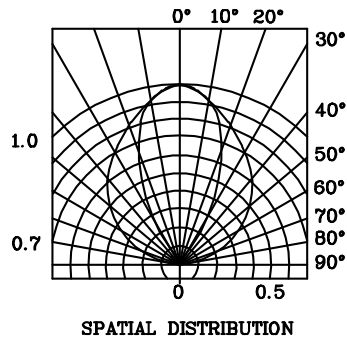
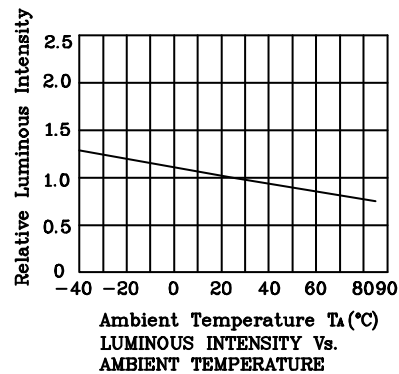
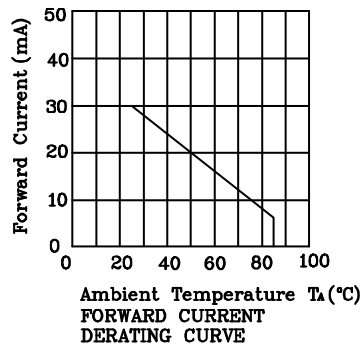
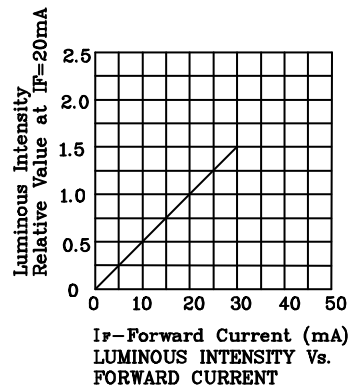
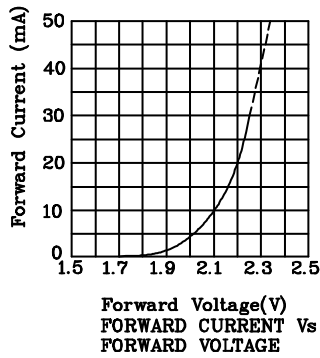
Absolute maximum ratings (TA=25°C)		ZE (InGaAlP)	Unit
Reverse voltage	VR	5	V
Forward current	IF	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	iFS	150	mA
Power dissipation	PT	120	mW
Operating temperature	TA	-40 ~ +85	°C
Storage temperature	Tstg	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics (TA=25°C)		ZE (InGaAlP)	Unit
Forward voltage (typ.) (IF=20mA)	VF	2.2	V
Forward voltage (max.) (IF=20mA)	VF	2.8	V
Reverse current (VR=5V)	IR	10	uA
Wavelength at peak emission (IF=20mA)	$\lambda$ peak	640	nm
Wavelength at Dominate emission (IF=20mA)	$\lambda$ D	630	nm
Spectral Line half-width (IF=20mA)	$\Delta\lambda$	25	nm
Capacitance (VF=0V, f=1MHz)	C	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm $\lambda$ P	Viewing Angle $2\theta$ 1/2
				min.	typ.		
XLZE20DLS DLCR	Red	InGaAlP	Red Semi Diffused	1800	2690	640	100°(H) 50°(V)

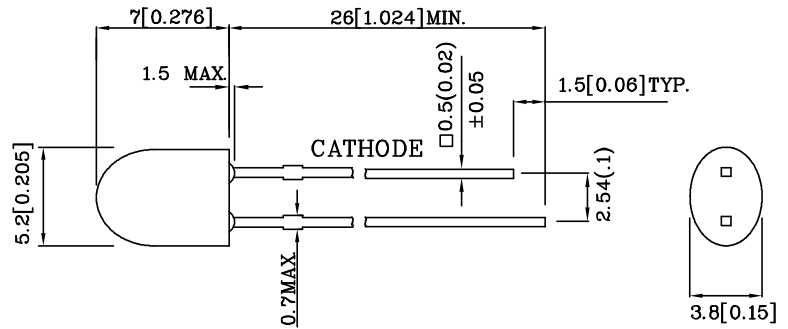


❖ ZE



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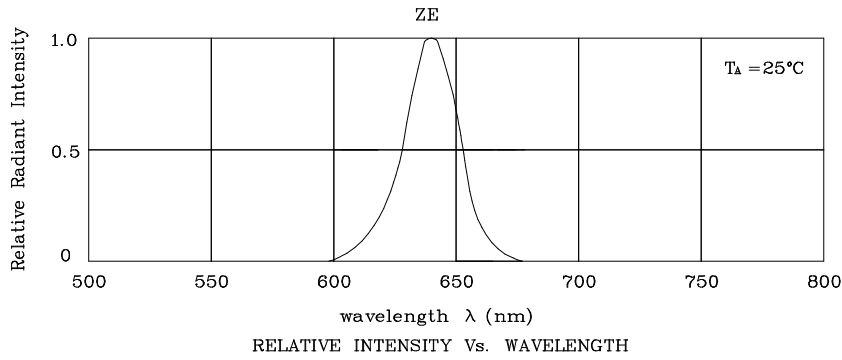
Notes:

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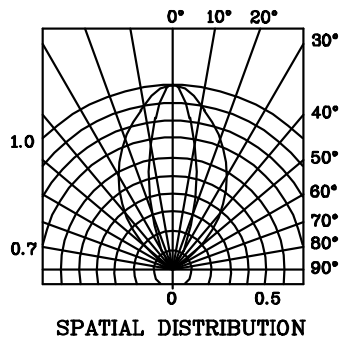
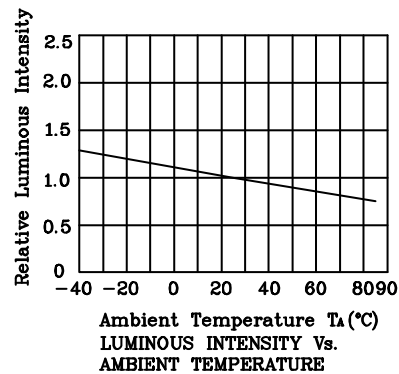
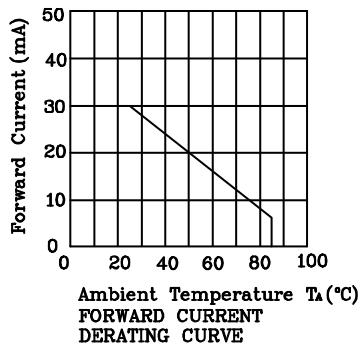
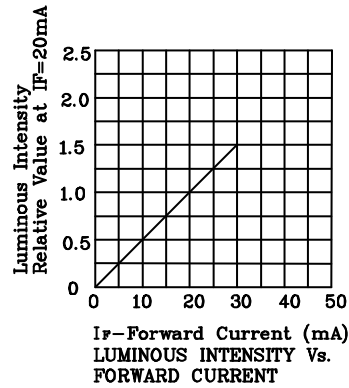
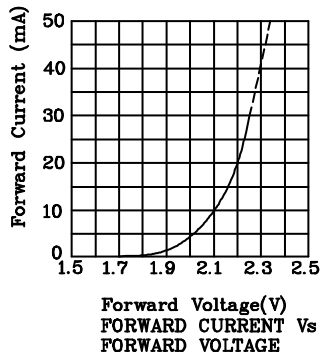
Absolute maximum ratings (TA=25°C)		ZE (InGaAlP)	Unit
Reverse voltage	VR	5	V
Forward current	IF	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	iFS	150	mA
Power dissipation	PT	120	mW
Operating temperature	TA	-40 ~ +85	°C
Storage temperature	Tstg	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics (TA=25°C)		ZE (InGaAlP)	Unit
Forward voltage (typ.) (IF=20mA)	VF	2.2	V
Forward voltage (max.) (IF=20mA)	VF	2.8	V
Reverse current (VR=5V)	IR	10	uA
Wavelength at peak emission (IF=20mA)	$\lambda$ peak	640	nm
Wavelength at Dominate emission (IF=20mA)	$\lambda$ D	630	nm
Spectral Line half-width (IF=20mA)	$\Delta\lambda$	25	nm
Capacitance (VF=0V, f=1MHz)	C	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm $\lambda$ P	Viewing Angle $2\theta$ 1/2
				min.	typ.		
XLZE20WLCR	Red	InGaAlP	Water Clear	2500	3495	640	70°(H) 30°(V)

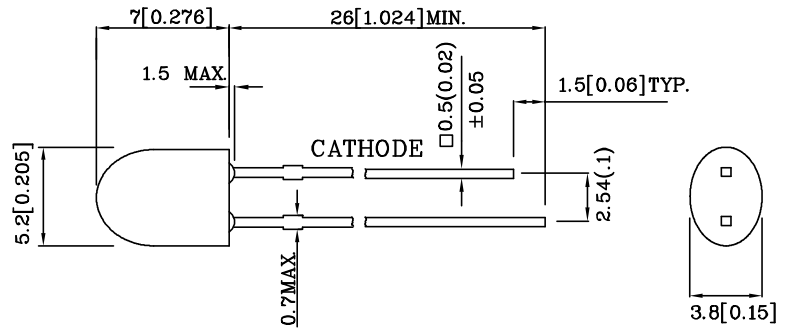


❖ ZE



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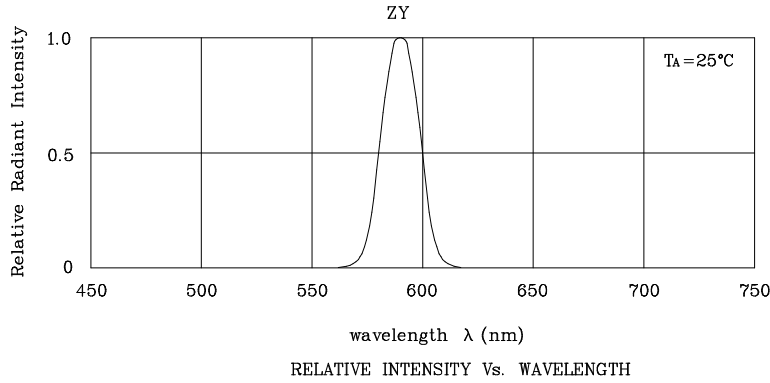
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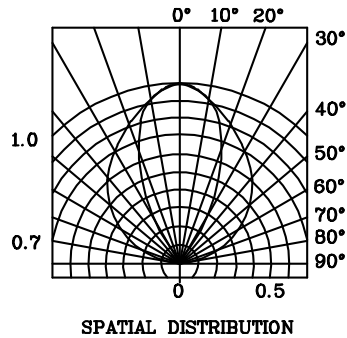
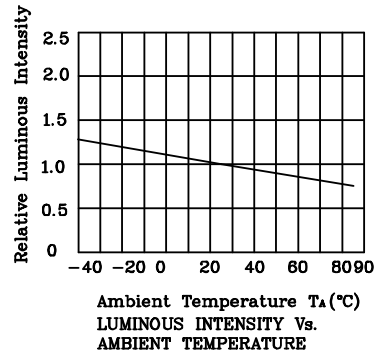
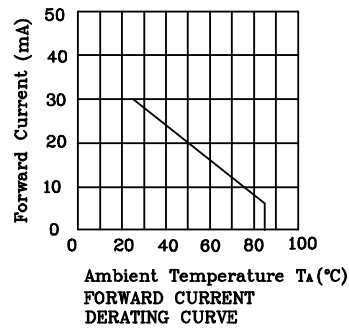
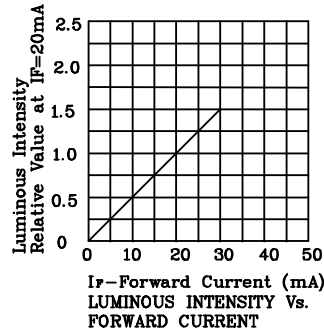
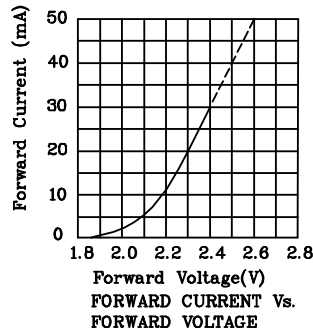
Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		ZY (InGaAlP)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	140	mA
Power dissipation	$P_T$	120	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		ZY (InGaAlP)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	2.3	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	2.8	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	590	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	589	nm
Spectral Line half-width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	20	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLZY20DLS DLCR	Yellow	InGaAlP	Yellow Semi Diffused	380	748	590	100°(H) 50°(V)

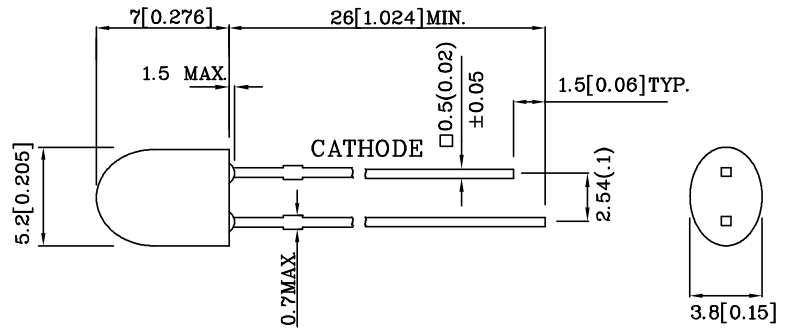


❖ ZY



**Features**

- OUTSTANDING MATERIAL EFFICIENCY.
- RELIABLE AND RUGGED.
- IC COMPATIBLE/LOW CURRENT CAPABILITY.



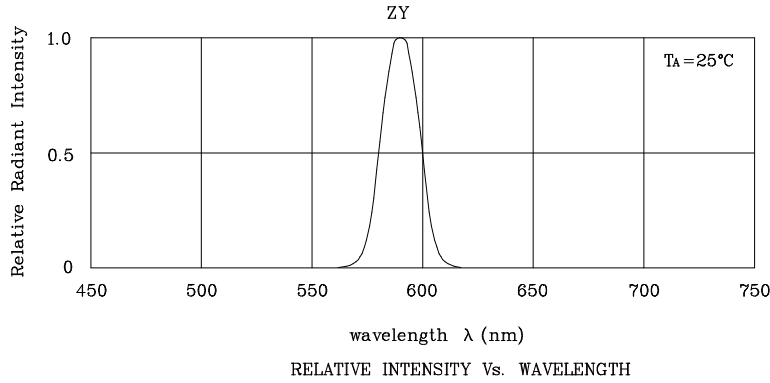
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.

Absolute maximum ratings ( $T_A=25^\circ\text{C}$ )		ZY (InGaAlP)	Unit
Reverse voltage	$V_R$	5	V
Forward current	$I_F$	30	mA
Forward current (peak) 1/10Duty cycle 0.1ms pulse width	$i_{FS}$	140	mA
Power dissipation	$P_T$	120	mW
Operating temperature	$T_A$	-40 ~ +85	°C
Storage temperature	$T_{stg}$	-40 ~ +85	
Lead solder temperature [2mm below package base]	260°C For 5 Seconds		

Operating Characteristics ( $T_A=25^\circ\text{C}$ )		ZY (InGaAlP)	Unit
Forward voltage (typ.) ( $I_F=20\text{mA}$ )	$V_F$	2.3	V
Forward voltage (max.) ( $I_F=20\text{mA}$ )	$V_F$	2.8	V
Reverse current ( $V_R=5\text{V}$ )	$I_R$	10	$\mu\text{A}$
Wavelength at peak emission ( $I_F=20\text{mA}$ )	$\lambda_{\text{peak}}$	590	nm
Wavelength at Dominate emission ( $I_F=20\text{mA}$ )	$\lambda_D$	589	nm
Spectral Line half-width ( $I_F=20\text{mA}$ )	$\Delta\lambda$	20	nm
Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ( $I_F=20\text{mA}$ ) mcd		Wavelength nm $\lambda_P$	Viewing Angle $2\theta_{1/2}$
				min.	typ.		
XLZY20WLCR	Yellow	InGaAlP	Water Clear	650	1095	590	70°(H) 30°(V)



❖ ZY

